

Docket No.: INTEL-0060

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PATENT

In re Application of

**EXPEDITED PROCEDURE  
UNDER 37 C.F.R. § 1.116**

Edward R. HURLEY et al.

Group Art Unit: 1725

Serial No.: 10/806,118

Filed: 3/23/2004

Examiner: R. Beveridge

Confirmation No.: 2131

Customer No.: 34610

For METALLIC SOLDER THERMAL INTERFACE MATERIAL LAYER AND APPLICATION OF THE SAME

U.S. Patent and Trademark Office  
Customer Window, Mail Stop AF  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314

Dear Sir:

Transmitted herewith is an Amendment and/or Reply in the above identified application.

- ☒ No additional fee is required.  
☐ Also attached:

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	30	30	0	x \$50.00 =	\$0.00
Independent Claims	3	5	0	x \$200.00=	\$0.00
If multiple claims newly presented, add \$360.00					\$0.00
Fee for extension of time					\$0.00
<b>TOTAL FEE DUE</b>					<b>\$0.00</b>

- ☐ Please charge my Deposit Account No. 16-0607 in the amount of \$. An additional copy of this transmittal sheet is submitted herewith.
- ☐ A check in the amount of \$ \_\_\_\_\_ (Check # \_\_\_\_\_) is attached.
- ☒ The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 16-0607, including any filing fees under 37 C.F.R. 1.16 for presentation of extra claims and any patent application processing fees under 37 C.F.R. 1.17.

Respectfully submitted,  
FLESPNER & KIM, LLP

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Date: July 31, 2006



Docket No. **INTEL-0069**

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re Application of:

**EXPEDITED PROCEDURE  
UNDER 37 C.F.R. §1.116**

**Edward R. HURLEY et al.**

Serial No.: **10/806,118**

Group Art Unit: **1725**

Confirmation No.: **2131**

Examiner: **R. Beveridge**

Filed: **March 23, 2004**

Customer No.: **34610**

For: **METALLIC SOLDER THERMAL INTERFACE MATERIAL LAYER AND  
APPLICATION OF THE SAME**

**AMENDMENT AFTER FINAL REJECTION  
UNDER 37 C.F.R. §1.116**

U.S. Patent and Trademark Office  
Customer Window, Mail Stop AF  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314

Sir:

In reply to the Office Action dated May 8, 2006, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims

**Remarks** begin after the listing of the claims.